

Features

- 2835 0.75mm SMD LED
- High Brightness
- White package
- High reliability
- Water Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-P23CTJR is a 2835 package with versatile design capabilities. It is a PLCC type LED which can be used in various applications.

Recommended Solder Pattern

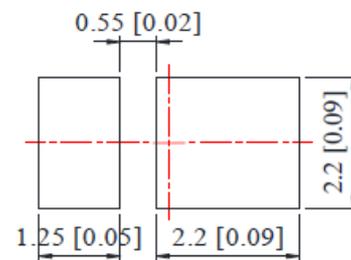
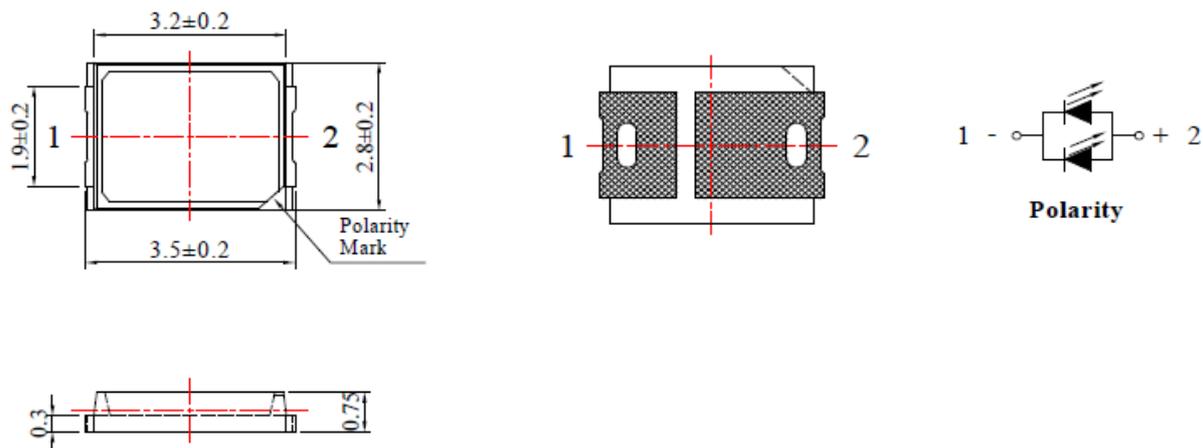


Figure 1. IN-P23CTJR Solder Pattern

Package Dimensions in mm



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 mm (.010") unless otherwise noted.

Figure 2. IN-P23CTJR Package Dimensions

Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (°C)	T _{ST} (°C)
IN-P23CTJR	Red	0.2	60	100	5	-40°C~+80°C	-40°C~+85°C

Notes

1. Derate linearly as shown in derating curve.
2. Duty Factor = 10%, Frequency = 1 kHz

Electrical Characteristics T_A = 25°C (Note 1)

Parameters	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Flux	IV	5	8	---	lm	IF=60mA
Viewing Angle	2θ1/2	---	120	---	Deg	IF=60mA
Peak Emission Wavelength	λ _p	---	632	---	nm	IF=60mA
Dominant Wavelength	λ _d	---	624	---	nm	IF=60mA
Spectral Line Half-Width	Δλ	---	20	---	nm	IF=60mA
Forward Voltage	V _F	1.6	2.1	2.4	V	IF=60mA
Reverse Current	I _R	---	---	10	μA	V _R =5V

Notes

1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
2. 2θ1/2 is the θ-axis angle where the luminous intensity is 1/2 the peak intensity
3. The dominant wavelength (λ_d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

ESD Precaution

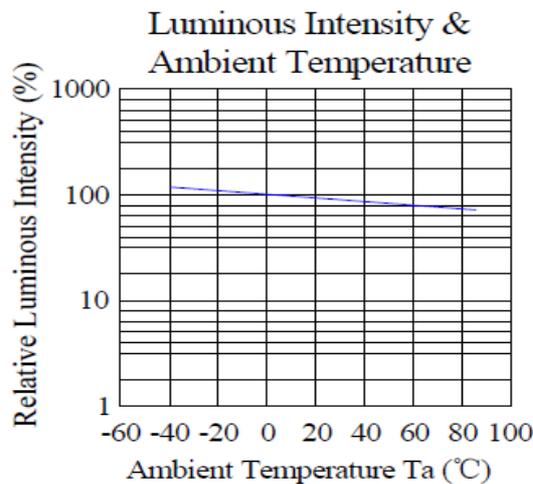
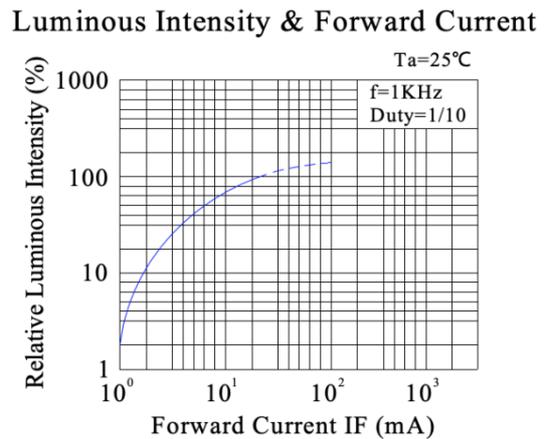
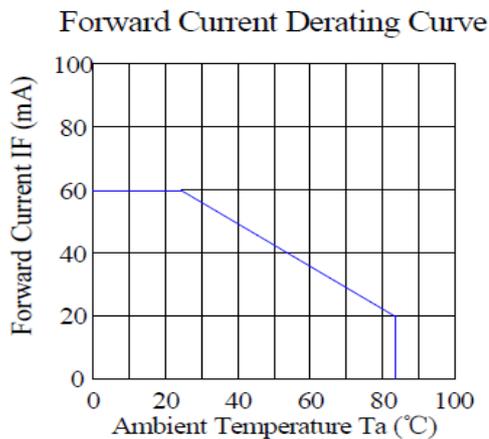
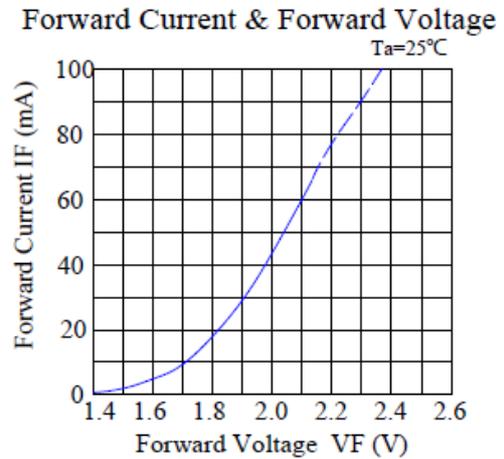
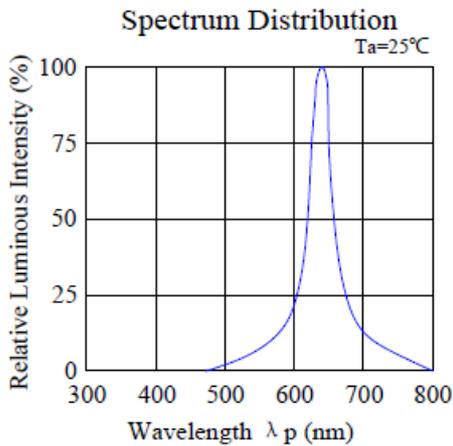
ATTENTION: Electrostatic Discharge (ESD) protection



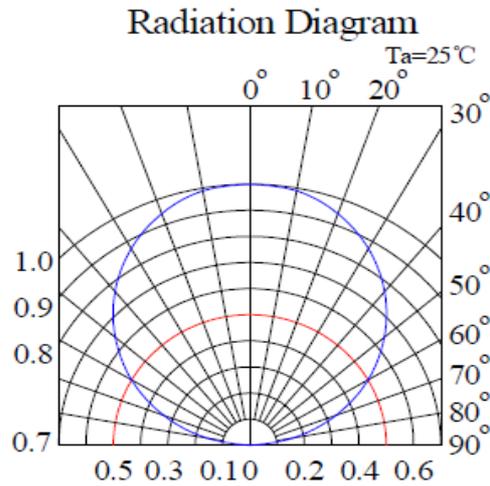
The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Typical Characteristic Curves



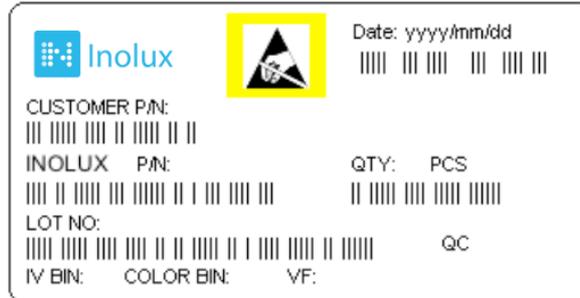
Typical Characteristic Curves – Radiation Pattern



Ordering Information

Product	Emission Color	Test Current I_F (mA)	Luminous Flux I_V (lm) (Typ.)	Forward Voltage V_F (V) (Typ.)	Orderable Part Number
IN-P23CTJR	Red	60	8	2.1	IN-P23CTJR

Label Specifications

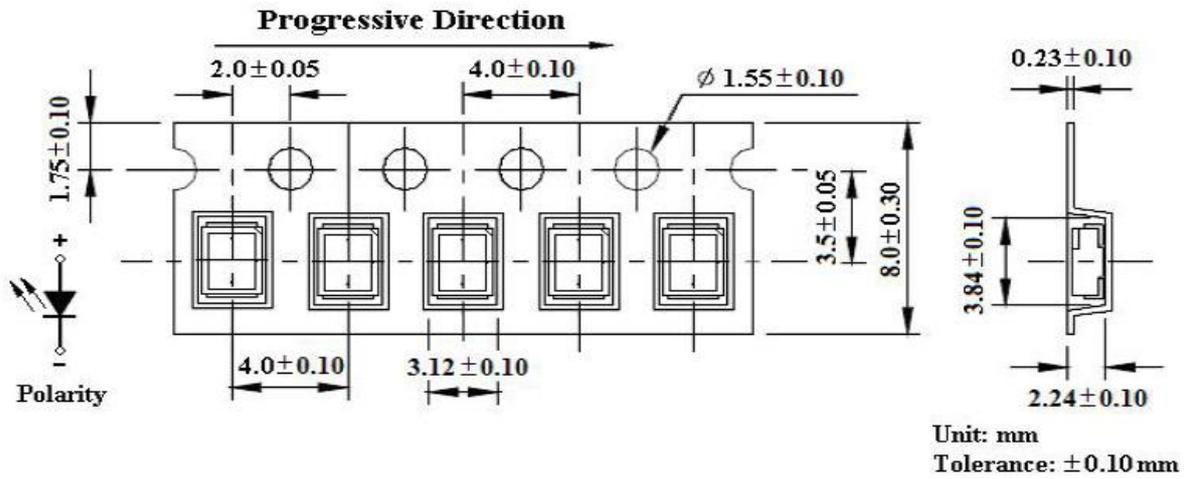
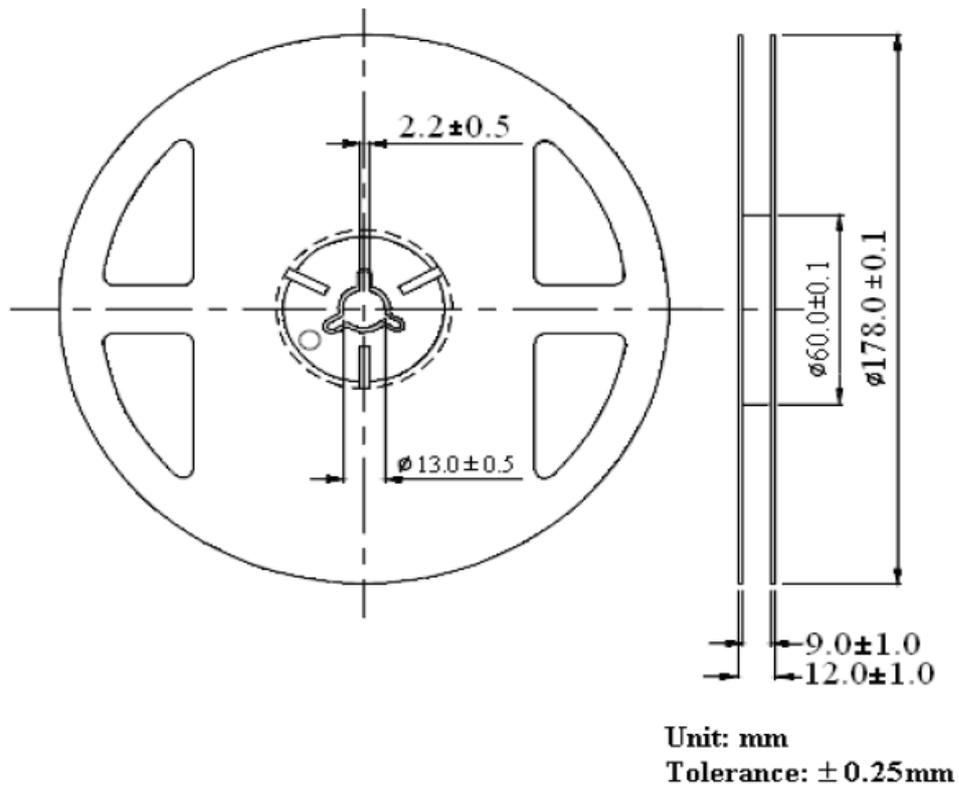


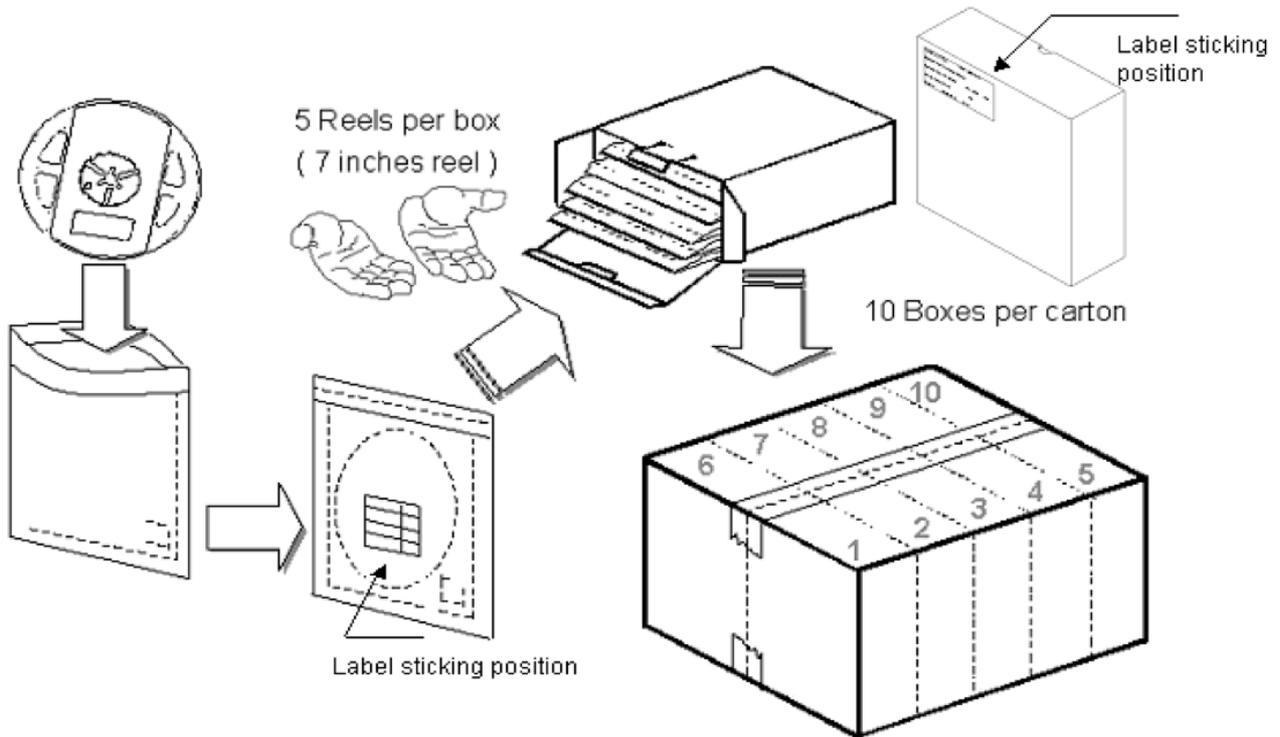
Inolux P/N:

I	N	-	P	2	3	C	T	J	R	-	X	X	X	X
Inolux SMD			Material	Package		Variation	Orientation	Current	Color		Customized Stamp-off			
			P = PLCC Type	23C=PLCC2 2835 Slug			T = Top Mount	J=60mA	R= Red					

Lot No.:

Z	2	0	1	8	01	24	001
Internal Tracker	Year (2018, 2019,)				Month	Date	Serial

Packaging Information: 4000pcs Per Reel
Tape Dimension

Reel Dimension


Packing Dimension


5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

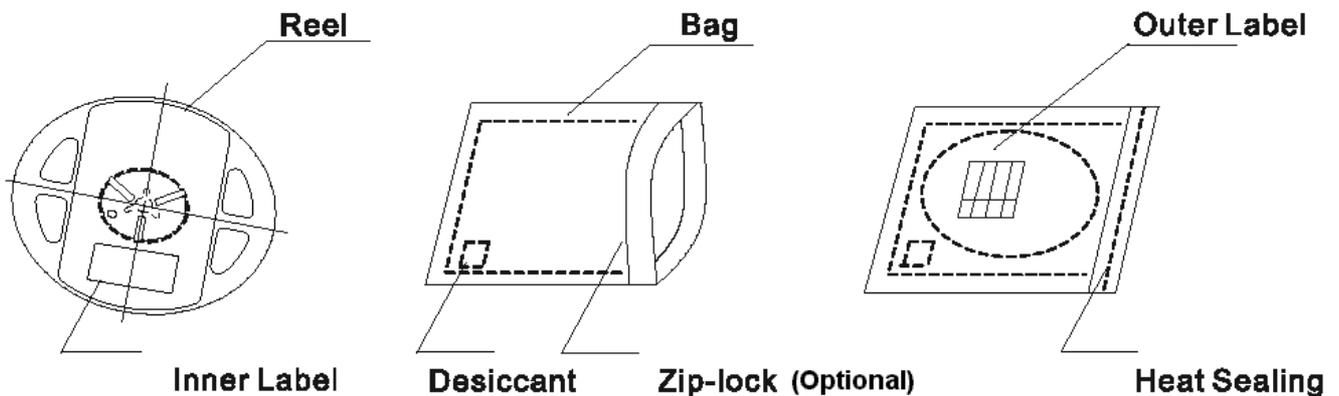
Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of I_v , λ_D and V_f . Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

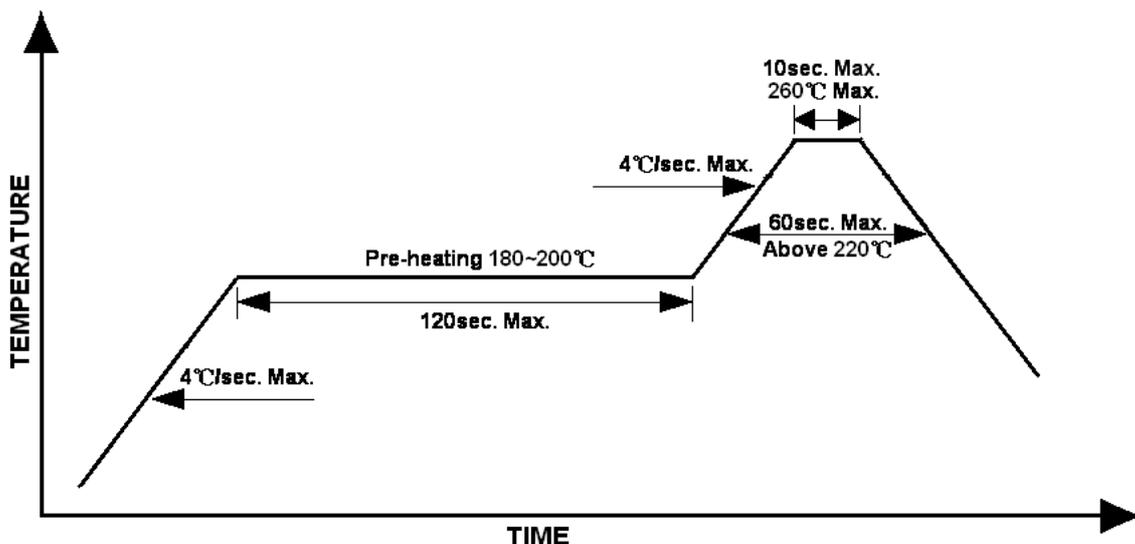
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	04-02-2020

DISCLAIMER

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.